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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/587,813	06/06/2000	Martyn Lott	AP32618(065838.0195)	8496

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EXAMINER
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LEE, SIN J

ART UNIT	PAPER NUMBER
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1752

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DATE MAILED: 08/20/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

**Office Action Summary**

Application No.

09/587,813

Applicant(s)

LOTT ET AL.

Examiner

Sin J Lee

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

**Period for Reply**

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

**Status**

- 1) ☒ Responsive to communication(s) filed on 28 May 2002.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

**Disposition of Claims**

- 4) ☒ Claim(s) 1-6 and 8-40 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☒ Claim(s) 9, 10 and 22-40 is/are allowed.
- 6) ☒ Claim(s) 1-6, 8, 11 and 13-21 is/are rejected.
- 7) ☒ Claim(s) 12 is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

**Application Papers**

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on \_\_\_\_\_ is: a) ☐ approved b) ☐ disapproved by the Examiner.
- If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

**Priority under 35 U.S.C. §§ 119 and 120**

- 13) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some \* c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- \* See the attached detailed Office action for a list of the certified copies not received.
- 14) ☒ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).
- a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

**Attachment(s)**

- 1) ☐ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☐ Information Disclosure Statement(s) (PTO-1449) Paper No(s) \_\_\_\_\_.
- 4) ☐ Interview Summary (PTO-413) Paper No(s). \_\_\_\_\_.
- 5) ☐ Notice of Informal Patent Application (PTO-152)
- 6) ☐ Other: \_\_\_\_\_.

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### **DETAILED ACTION**

1. The papers filed on May 28, 2002 have not been made part of the permanent records of the United States Patent and Trademark Office (Office) for this application (37 CFR 1.52(a)) because of damage from the United States Postal Service irradiation process. The above-identified papers, however, were not so damaged as to preclude the USPTO from making a legible copy of such papers. Therefore, the Office has made a copy of these papers, substituted them for the originals in the file, and stamped that copy:

**COPY OF PAPERS**

**ORIGINALLY FILED**

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If applicant wants to review the accuracy of the Office's copy of such papers, applicant may either inspect the application (37 CFR 1.14(d)) or may request a copy of the Office's records of such papers (*i.e.*, a copy of the copy made by the Office) from the Office of Public Records for the fee specified in 37 CFR 1.19(b)(4). Please do **not** call the Technology Center's Customer Service Center to inquiry about the completeness or accuracy of Office's copy of the above-

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identified papers, as the Technology Center's Customer Service Center will **not** be able to provide this service.

If applicant does not consider the Office's copy of such papers to be accurate, applicant must provide a copy of the above-identified papers (except for any U.S. or foreign patent documents submitted with the above-identified papers) with a statement that such copy is a complete and accurate copy of the originally submitted documents. If applicant provides such a copy of the above-identified papers and statement within **THREE MONTHS** of the mail date of this Office action, the Office will add the original mailroom date and use the copy provided by applicant as the permanent Office record of the above-identified papers in place of the copy made by the Office. Otherwise, the Office's copy will be used as the permanent Office record of the above-identified papers (*i.e.*, the Office will use the copy of the above-identified papers made by the Office for examination and all other purposes). This three-month period is not extendable.

2. Upon reconsideration, the previously made rejections on claim 12 over McCullough et al (WO'715) in view of Nakao et al'942 and over McCullough et al (WO'715) in view of Yoshioka'108 are hereby withdrawn. It is the Examiner's position that one of ordinary skill in the art would not be motivated to combine the teaching of McCullough with Nakao or Yoshioka because McCullough is already covering their plate samples with interleaving and then wrap them in paper coated with polythene (which, in the Examiner's opinion, is already sufficiently inhibiting removal of moisture from the plate samples during the heat treatment) and the

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reference does not provide motivation why one would want to go through even more steps to carry out the heat treatment in an atmosphere containing water vapor as taught in Nakao or in a casing into which a H<sub>2</sub>O component is supplied through a gas supply mechanism as taught by Yoshioka. Besides, there is a big difference in the duration of McCullough's heat treatment (at least 24 hours) and that of Nakao (90 seconds) or Yoshioka (70-150 seconds).

3. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

4. Claims 1-6, 8, 11, 13-19, and 21 are rejected under 35 U.S.C. 102(b) as being anticipated by McCullough et al (WO 99/21715) (with Dammel et al (5,510,420) cited here to show that typical novolak resins have glass transition temperature between 90-120°C).

McCullough teaches (pg.4, lines 9-17, pg.10, lines 11-19) a method of manufacturing a *printing form precursor* which comprises a coating on a substrate, the coating comprising a

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*positive* working composition which comprises a *phenolic resin* (particularly *novolak resin*), wherein the method comprises the application of the composition in a solvent to the substrate, the drying of the composition, and the subsequent *heat treatment* of the coated substrate.

McCullough furthermore teaches (pg.6, lines 25-27) that by carrying out a suitable heat treatment, the sensitivity of the composition may be rendered less variable over time.

McCullough also teaches (pg.7, lines 33-35, pg.8, lines 1-4) that they favor carrying out the heat treatment preferably for *at least 24 hours* and at a temperature of *at least 40°C and not excess of 90°C*. In Example 1, McCullough's heat treatment is carried out as follows; individual plate samples (which comprises dried coating formulations coated onto substrates) are first covered with interleaving (a *polythene* coated paper No.22) and then wrapped in paper (unbleached, unglazed Kraft 90 gm<sup>-2</sup>, *coated with matt black low density polythene* 20 gm<sup>-2</sup>, and placed in an Gallenkamp hotbox oven with fan at 50°C for 0, 2, 3, 5, and 12 days respectively. Since applicants in their Example 1 also use *polythene* to wrap their precursors before placing them in an oven (fore 3 days at 55°C), it is the Examiner's position that the prior art teaches present limitation "the heat treatment step taking place under conditions which inhibit the removal of moisture from the precursor during the heat treatment". Therefore, the prior art teaches present inventions of claims 1-5, 8, 11, 17, and 19.

With respect to present claim 6, it is known in the art that typical novolak resins have glass transition temperatures between 90-120°C as evidenced by Dammel et al, col.1, lines 48-50. Therefore, when one carries out McCullough's heating treatment at 50°C as taught in his

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Example 1, it would inherently be the case that the glass transition temperature of the novolak resin (90-120°C) is not exceeded in the heat treatment as presently claimed in claim 6.

Therefore, the prior art teaches the present invention of claim 6.

With respect to present claim 13, McCullough teaches (pg.6, lines 20-22) that his composition is preferably such that its solubility in a developer is not increased by incident UV radiation, and thus the prior art teaches present invention of claim 13.

With respect to present claim 14, McCullough teaches (pg.11, lines 12-34) that his composition is preferably patternwise solubilized by heat, during the pattern forming exposure process, by using direct heat or charged-particle radiation, for example electron beam radiation. Therefore, the prior art teaches present invention of claim 14.

With respect to present claim 15, McCullough teaches (pg.12, lines 15-29) that more preferably, his compositions can be exposed directly by means of a laser emitting radiation at above 600 nm and below 1400 nm and that in such compositions a suitable radiation absorbing compound such as carbon black or graphite can be used to convert the radiation to heat. Therefore, the prior art teaches present invention of claim 15.

McCullough teaches (pg.25, lines 7-16) a positive working lithographic printing form precursor having a coating comprising of a composition comprising an active polymer and a *reversible insolubilizer compound* coated on a support wherein the aqueous developer solubility of the composition is increased on heating and that the aqueous developer solubility of the

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composition is not increased by incident UV radiation, and thus the prior art teaches present invention of claim 16.

With respect to present claim 18, since McCullough teaches the present steps (a) and (b) of claim 18, it is the Examiner's position that the method taught by McCullough would inherently be capable of forming an electronic part precursor as present claimed in claim 18.

With respect to present claim 21, in his Example 1, after the heat treatment, McCullough imagewise exposes his heat-treated plates using the Creo Trendsetter at 7 watts and then develop the plates using a Horsell Mercury Mark V plate processor containing developer. Therefore, the prior art teaches present invention of claim 21.

5. Claims 17, 18, 20, and 21 are rejected under 35 U.S.C. 102(b) as being anticipated by Nakao et al (5,667,942).

Nakao teaches a resist pattern forming method (for forming a resist pattern in a lithographic step in a semiconductor device fabrication process) which includes: (i) an application step of applying a photoresist onto a semiconductor substrate; (ii) a prebake step (before the imagewise exposure) of prebaking the photoresist *in an atmosphere containing water vapor* following the application of the photoresist to the substrate; (iii) an exposure step of exposing the photoresist to radiation following the prebake step; (iv) a heating step of heating the photoresist following the exposure step; and (v) a development step of developing the photoresist following the heating step. See abstract. Nakao's method is intended to control the water content



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in a resist film for improvement of sensitivity of the resist (see col.2, lines 23-28). That is, the prebake step is conducted in an atmosphere containing water vapor, so that *a large amount of water is imparted to* and therefore *becomes present in the resist film* for high solution speed of an exposed part into developer, with a result of high resist sensitivity (see col.3, lines 23-28). Also, Nakao teaches a positive type resist made of novolak resin, and naphthoquinonediazido photosensitizer. Therefore, the prior art teaches the present invention of claims 18, 20, and 21.

With respect to present claim 17, since Nakao teaches the present steps (a) and (b) of claim 17, it is the Examiner's position that Nakao's method would inherently be capable of forming a printing form precursor as presently recited.

6. Claims 17, 18, 20, and 21 are rejected under 35 U.S.C. 102(e) as being anticipated by Yoshioka (6,002,108).

Yoshioka teaches (col.1, lines 5-7) a baking apparatus and a baking method for baking a resist film coated on a substrate such as a semiconductor wafer. After the surface of the wafer is coated with a photoresist, it is then exposed to light together with a predetermined pattern, and developed (col.1, lines 11-14). Yoshioka states (col.1, lines 20-23) that the series of resist processing steps include various baking processes performed for different purposes, and that prebake is made to stabilize the resist. Yoshioka teaches (col.1, lines 54-67, col.2, lines 1-8) that his baking apparatus comprises a casing surrounding a substrate, a hot plate for heating the substrate in the casing, a gas supply mechanism for supplying a H<sub>2</sub>O component containing

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humidity gas into the casing, and preferably further comprises a cover provided closely to the substrate in the casing for forming a process space for baking the resist film between the cover and the substrate. If such a small process space is formed between the cover and the substrate, H<sub>2</sub>O component contained in the humidity gas can be efficiently reacted with the resist film, with the result that a quality of the resist film is improved, increasing the throughput of the baking process. Yoshioka clearly teaches (col.6, lines 56-57) that his baking apparatus is used for baking process such as *prebake for stabilizing the resist before light exposure*, as well as post exposure bake after the light exposure. Also, Yoshioka teaches (col.3, lines 4-65, col.4, col.5, lines 1-40) a chemically amplified resist comprising an acetal-protected polyhydroxystyrene, which is alkali-insoluble before the exposure but becomes alkali-soluble upon exposure in the presence of a photoacid generator. Therefore, the prior art teaches the present inventions of claims 18, 20, and 21.

With respect to present claim 17, since Yoshioka teaches the present steps (a) and (b) of claim 17, it is the Examiner's position that the prior art's method would inherently be capable of forming a printing form precursor as presently recited.

7. Claims 17-19 and 21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Takata et al (6,143,471) in view of Nakao et al (5,667,942).

Takata teaches (col.2, lines 52-65) a *positive* type photosensitive composition capable of making a lithographic printing plate comprising a polymer which is soluble in an alkaline

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developer, a near infrared rays-absorbing dye, and a compound which lowers solubility of the polymer in the alkaline developer. Takata dissolves his positive photosensitive composition in a solvent and coats it on a support (col.32, lines 62-67). After the coating and drying, a lithographic printing plate is prepared by imagewise exposing the positive photosensitive composition (by irradiating with a semiconductor laser which irradiates near infrared rays at a wavelength of 700-900 nm) and then developing the exposed plate material using an alkaline developer (see col.33, line 15, lines 56-60, col.34, lines 31-32). Takata teaches (see Example 1) that the drying step (after the coating of the photosensitive composition) is done at 40°C for 20 minutes. However, Takata does not does not teach the presently claimed heat treatment step in which removal of moisture from the precursor is inhibited during the heat treatment. Nakao teaches (col.2, lines 23-37) that carrying out a prebake step (after applying a photoresist onto a substrate) in an atmosphere containing water vapor improves sensitivity of the photoresist. Based on Nakao's teaching, it would have been obvious to one of ordinary skill in the art to carry out Takata's drying step (at 40°C for 20 minutes) in an atmosphere containing water vapor in order to improve sensitivity of the photoresist as taught by Nakao. Therefore, Takata in view of Nakao would render obvious the present inventions of claims 17, 19, and 21.

With respect to present claim 18, since Takata in view of Nakao teach the present steps (a) and (b) of claim 18, it is the Examiner's position that the method taught by Takata in view of

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Nakao would inherently be capable of forming an electronic part precursor as present claimed in claim 18.

8. Claims 17-19, and 21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Takata et al (6,143,471) in view of Yoshioka (6,002,108).

Takata teaches (col.2, lines 52-65) a *positive* type photosensitive composition capable of making a lithographic printing plate comprising a polymer which is soluble in an alkaline developer, a near infrared rays-absorbing dye, and a compound which lowers solubility of the polymer in the alkaline developer. Takata dissolves his positive photosensitive composition in a solvent and coats it on a support (col.32, lines 62-67). After the coating and drying, a lithographic printing plate is prepared by imagewise exposing the positive photosensitive composition (by irradiating with a semiconductor laser which irradiates near infrared rays at a wavelength of 700-900 nm) and then developing the exposed plate material using an alkaline developer (see col.33, line 15, lines 56-60, col.34, lines 31-32). Takata teaches (see Example 1) that the drying step (after the coating of the photosensitive composition) is done at 40°C for 20 minutes. However, Takata does not does not teach the presently claimed heat treatment step in which removal of moisture from the precursor is inhibited during the heat treatment. Yoshioka teaches (col.1, lines 22-23, lines 53-67, col.2, lines 1-8, col.6, lines 56-57) a prebaking step using a baking apparatus which has a casing surrounding a substrate and a gas supply mechanism for supplying a H<sub>2</sub>O component containing humidity gas in order to stabilize the resist. Based on

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Yoshioka's teaching, it would have been obvious to one of ordinary skill in the art to carry out Takata's drying step (at 40°C for 20 minutes) using Yoshioka's baking apparatus in order to stabilize the resist. Therefore, Takata in view of Yoshioka would render obvious the present inventions of claims 17, 19, and 21.

With respect to present claim 18, since Takata in view of Yoshioka teach the present steps (a) and (b) of claim 18, it is the Examiner's position that the method taught by Takata in view of Nakao would inherently be capable of forming an electronic part precursor as present claimed in claim 18.

9. Claim 12 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims. As explained above in Paragraph 1, one of ordinary skill in the art would not be motivated to combine the teaching of McCullough with Nakao or Yoshioka because McCullough is already covering their plate samples with interleaving and then wrap them in paper coated with polythene (which, in the Examiner's opinion, is already sufficiently inhibiting removal of moisture from the plate samples during the heat treatment) and the reference does not provide motivation why one would want to go through even more steps to carry out the heat treatment in an atmosphere containing water vapor as taught in Nakao or in a casing into which a H<sub>2</sub>O component is supplied through a gas supply mechanism as taught by Yoshioka. Besides,

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there is a big difference in the duration of McCullough's heat treatment (at least 24 hours) and that of Nakao (90 seconds) or Yoshioka (70-150 seconds).

10. Claim 9 is allowed. None of the cited prior arts teaches or suggests applying the heat treatment to a precursor coil.

11. Claims 10, 22-35 (which depend from claim 10), and 36-40 (which incorporate subject matter of claim 10) are allowed. Although McCullough teaches applying his heat treatment to 13 plates packet (see Example 9), the prior art does not teach or suggest that his heat treatment can be applied to a stack of at least 100 precursors as presently claimed in claim 10.

12. First, applicants argue that since in McCullough's Example 1, the edges of the wrapping are not sealed down, the procedure of McCullough does not inhibit removal of moisture. The Examiner disagrees. As explained above, McCullough is covering their plate samples with interleaving, which is a polythene coated paper, and then wrap them again in paper coated with polythene. It is the Examiner's position that McCullough's method is already sufficiently inhibiting removal of moisture from the plate samples during the heat treatment. Besides, applicants themselves state on pg.7 and 11 of present specification that their heat treatment *,which will inhibit the removal of moisture from a precursor during the heat treatment,* takes place with the precursor *wrapped* or encased in an impermeable sheet material, and only *preferably*, the material is sealed. Also, present claim language does not require that the edges of the wrapping are to be sealed down.

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Applicants argue that Claims 17, 18, 20, and 21 are not anticipated by Nakao or Yoshioka by saying that in Nakao or Yoshioka, the precursors come in contact with the surrounding atmosphere containing water, a state of equilibrium is reached in which moisture is transferred to and removed from the precursors at the same rate and that therefore, Nakao or Yoshioka does not disclose or suggest inhibiting the removal of moisture present in the precursor. However, applicants themselves state on pg.7 of present specification that another way of inhibiting removal of moisture from a precursor (other than wrapping the precursor in a water-impermeable sheet material) during the heat treatment is to carry out the heat treatment in a *non-drying environment*, and it is the Examiner's position that that is exactly what Nakao or Yoshioka is doing. As discussed above, Nakao prebakes his photoresist film in an *atmosphere containing water vapor* and this method makes large amount of water to be imparted to and to be present in the resist film. Yoshioka's baking apparatus comprises a casing into which the water component containing humidity gas is supplied. Therefore, both Nakao's and Yoshioka's heat treatments are certainly being carried out in a non-drying environment.

Applicants also argue that the prebake of Nakao or Yoshioka in the presence of water vapor is carried out so that the exposed coating will develop away quickly in a developer whereas in the present invention the purpose of wrapping the precursors is to allow the coating at the edges of the printing plates to remain after development. The Examiner disagrees. Applicants state on pg.24 of their specification that the developer solubility of the coating after it has been

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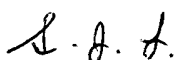
subjected to heat during patternwise exposure is greater than the solubility of the corresponding unexposed coating. Applicants furthermore state that the measure to increase this solubility differential reduce the solubility of the polymeric composition, prior to the patternwise exposure. On subsequent patternwise exposure, applicants state that the *exposed areas of the coating are rendered more soluble in the developer than the unexposed areas*. Thus, in the exposed areas the coating is dissolved just as in Nakao or Yoshioka.

For the reasons stated above, the rejections on present claims 1-6, 8, 11, 13-21 still stand.


13. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Sin J. Lee whose telephone number is (703) 305-0504. The examiner can normally be reached on Monday-Friday from 8:30 am EST to 5:00 pm EST.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Ms. Janet Baxter, can be reached on (703) 308-2303. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9311 for after final responses or (703) 872-9310 for before final responses.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 305-0661.



S. Lee  
August 19, 2002

  
JANET BAXTER  
SUPERVISORY PATENT EXAMINER  
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